

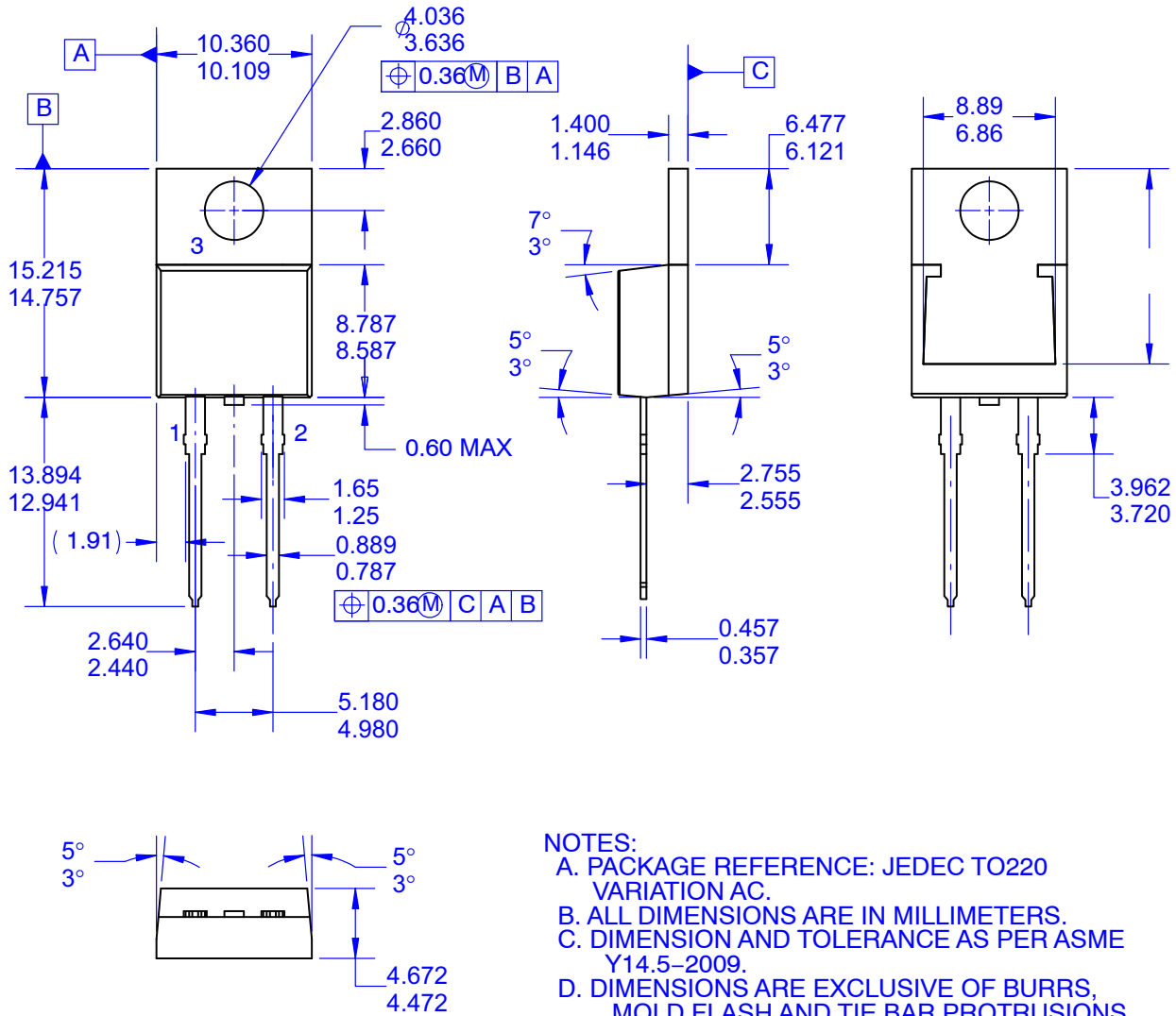
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

ON Semiconductor®



TO-220-2LD
CASE 340BA
ISSUE O

DATE 31 AUG 2016



- NOTES:**
- A. PACKAGE REFERENCE: JEDEC TO220 VARIATION AC.
 - B. ALL DIMENSIONS ARE IN MILLIMETERS.
 - C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
 - D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

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